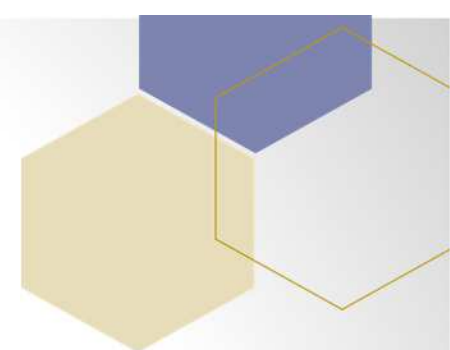
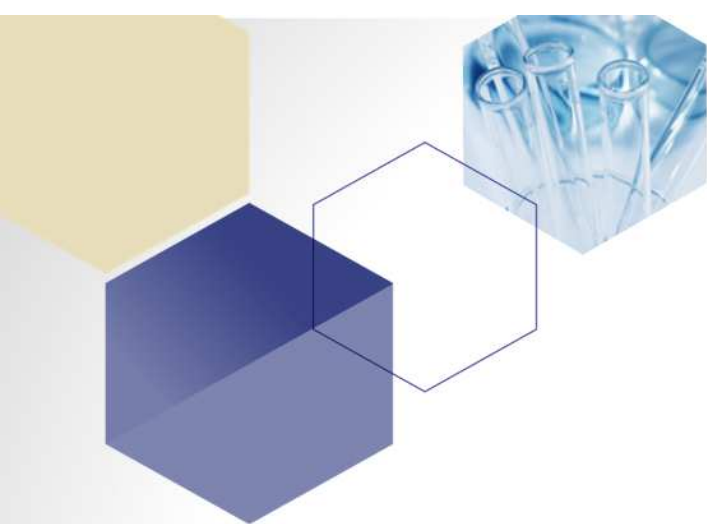




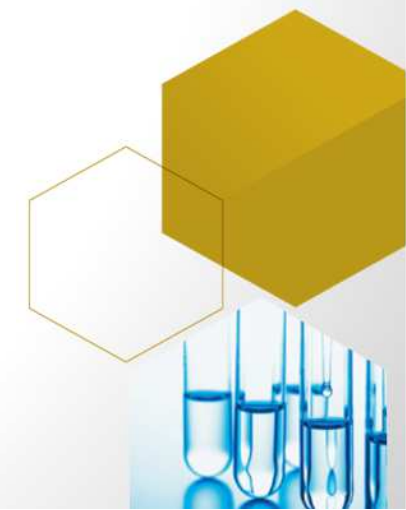
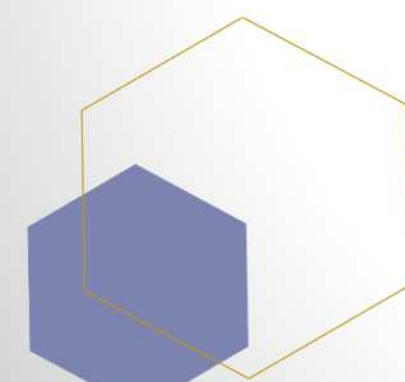
Financial Results for the First quarter Ended June 30, 2026

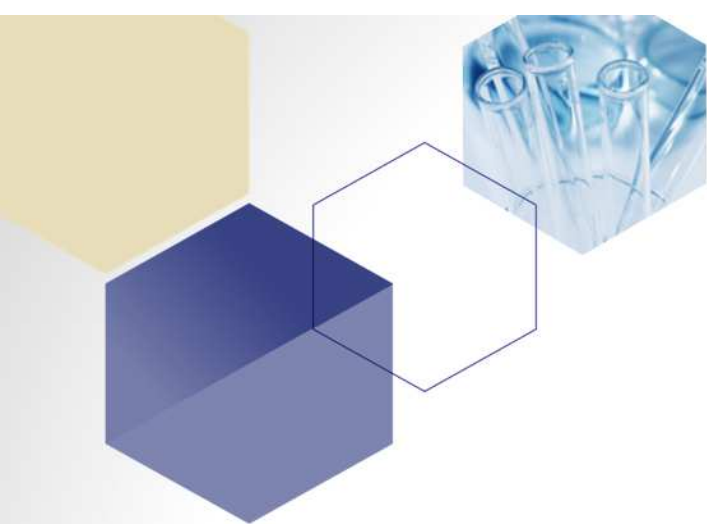


JAPAN PURE CHEMICAL CO.,LTD.

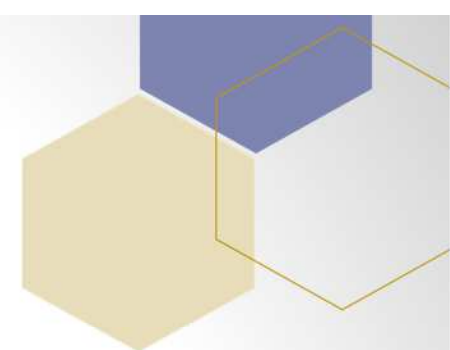
Securities Code: 4973

July 24, 2026





Summary of Financial Results



Key points on how to read the Company's business results

- Sales vary significantly between selling noble metals with chemicals and selling chemicals alone.
- Noble metals have a significant impact on sales because they are expensive and their prices fluctuate.

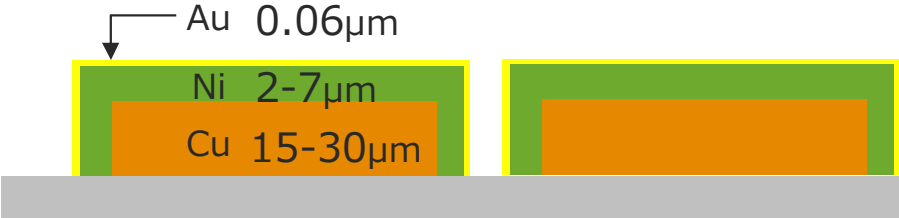
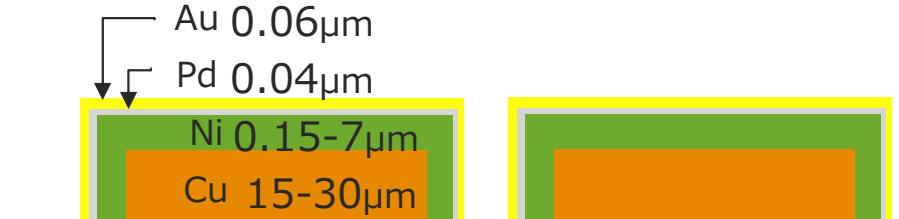
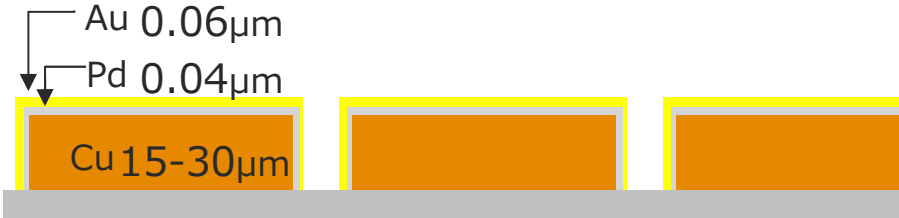
Plating Method

Term	Applications	Features
Electrolytic plating	—	Plating method on metal surfaces with electric current
Pure gold plating	Printed circuit boards (CPU, GPU, etc.) for PCs, smartphones, etc.	High-purity gold plating
Hard gold plating	Connectors for smartphones, automotive, industrial machinery, etc.	Gold plating that is hardened with alloy components
Palladium (Pd) plating	Lead frames for PCs, automotive, industrial machinery, etc.	Used as an undercoat for gold plating. PPF stands for Pre Plated Lead frame.
Electroless plating	—	Plating method by chemical reaction without electric current
Immersion plating	Semiconductor memory(DRAM, NAND) Substrates with semiconductors for servers, PCs, smart phones, etc.	Plating method for forming by replacing metal on surface by utilizing solubility (ionization tendency) of each metal
Auto catalytic plating(Au)	Semiconductor Mounted Substrate CPU, GPU, etc. for servers, PCs, etc.	Plating method capable of forming thick coatings by utilizing chemical reaction with reducing agents
Auto catalytic plating(Pd)	Semiconductor Mounted Substrate for PC, server	Plating method capable of forming thick coatings by utilizing chemical reaction with reducing agents used as a base for gold plating

Product Lineup

Plating Methods		Applications	Product Lineup	
Electrolytic plating	Pure gold		1. Pure gold plating enabling uniform coating even on rough surfaces 2. Pure gold plating with higher hardness	TEMPERESIST Series
	Hard gold (Alloy)		Gold saving hard gold plating for micro connectors: OROBRGHT BAR7	OROBRIGHT BAR7
	Palladium (Pd)		Palladium plating for thin coating applicable to PPF: PALLABRIGHT NANO2	PALLABRIGHT NANO2
Electroless plating	Immersion gold		Immersion gold plating compatible with mid- to high-P Ni: IM-GOLD IB2X Immersion gold plating with less Ni corrosion: IM-GOLD CN Immersion gold plating without Ni plating: IM-GOLD PC	IM-GOLD IB2X IM-GOLD CN IM-GOLD PC
	Auto catalytic gold		Auto catalytic gold plating for thin coating using gold sulfite: HY-GOLD Auto catalytic gold plating for thin coating using gold cyanide: HY-GOLD CN	HY-GOLD HY-GOLD CN
	Auto catalytic palladium		Auto catalytic palladium plating for ENEPIG: NEO PALLABRIGHT 2 Direct auto catalytic palladium plating: NEO PALLABRIGHT DP	NEO PALLABRIGHT 2 NEO PALLABRIGHT DP
Peripheral fields			Base metals (copper, tin, nickel) Alloy plating, Post-treatment agents	

Plating Process Description

Term	Description	Composition of plating
ENIG	Electroless Nickel Immersion Gold. Composition of plating is Cu-Ni-Au.	 Au 0.06µm Ni 2-7µm Cu 15-30µm
ENEPIG	Electroless Nickel Electroless Palladium Immersion Gold. Composition of plating is Cu-Ni-Pd-Au.	 Au 0.06µm Pd 0.04µm Ni 0.15-7µm Cu 15-30µm
DIG	Direct Immersion Gold. Since Ni plating is omitted, used for fine pitch compared to ENIG. Composition of plating is Cu-Au.	 Au 0.06µm Cu 15-30µm
EPIG	Electroless Palladium Immersion Gold. Composition of plating is Cu-Pd-Au.	 Au 0.06µm Pd 0.04µm Cu 15-30µm

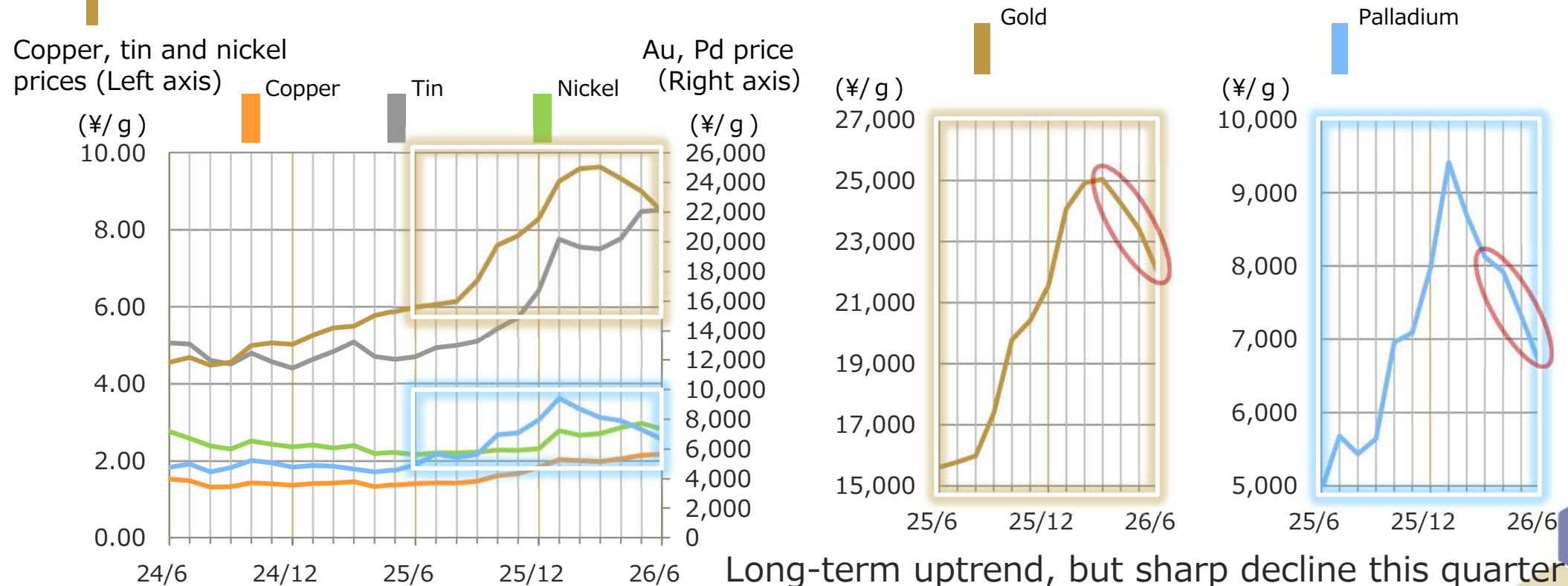
Au: gold, Pd: palladium, Ni: nickel, Cu: copper,
Micrometer (µm): one millionth of one meter

FY2027/3 External Environment of the First quarter

Market Conditions in the Electronic Components Industry

- Strong demand for AI servers/data centers driven by hyperscaler AI investment; industrial equipment demand remained solid.
- Consumer electronics (PCs, smartphones) demand softened due to higher memory prices.
- Automotive electronics demand was supported by ADAS/SDV adoption, but growth remained limited amid U.S. EV policy changes and weaker demand in China.

Historical Metal Prices



FY2027/ 3 First Quarter Financial Summary

Overview of Our Financial Results: Revenue Increased, Profit Decreased

- Net Sales: Solid consumer demand (Smartphones/PCs), strong sales for semiconductor package/module and memory applications, and higher noble metal prices ※¹ drove +80.6% YoY.
- Operating Profit: Higher sales volume was offset by inventory valuation losses from lower noble metal prices ※², resulting in –66.3% YoY.
- Quarterly Profit : Lower operating profit resulted in –34.5% YoY.

(M ¥)	FY2026/3	FY2027/3			
	1Q	1 Q	Increase/ Decrease ratio	Annual Forecast	Q1 progress ratio
Net sales	3,406	6,152	+80.6%	24,000	25.6%
Operating profit	92	31	(66.3%)	610	5.1%
Ordinary profit	184	122	(33.4%)	800	15.4%
Net profit	135	88	(34.5%)	2,170	4.1%
Net profit per share (Yen)	23.40	15.25	—	—	

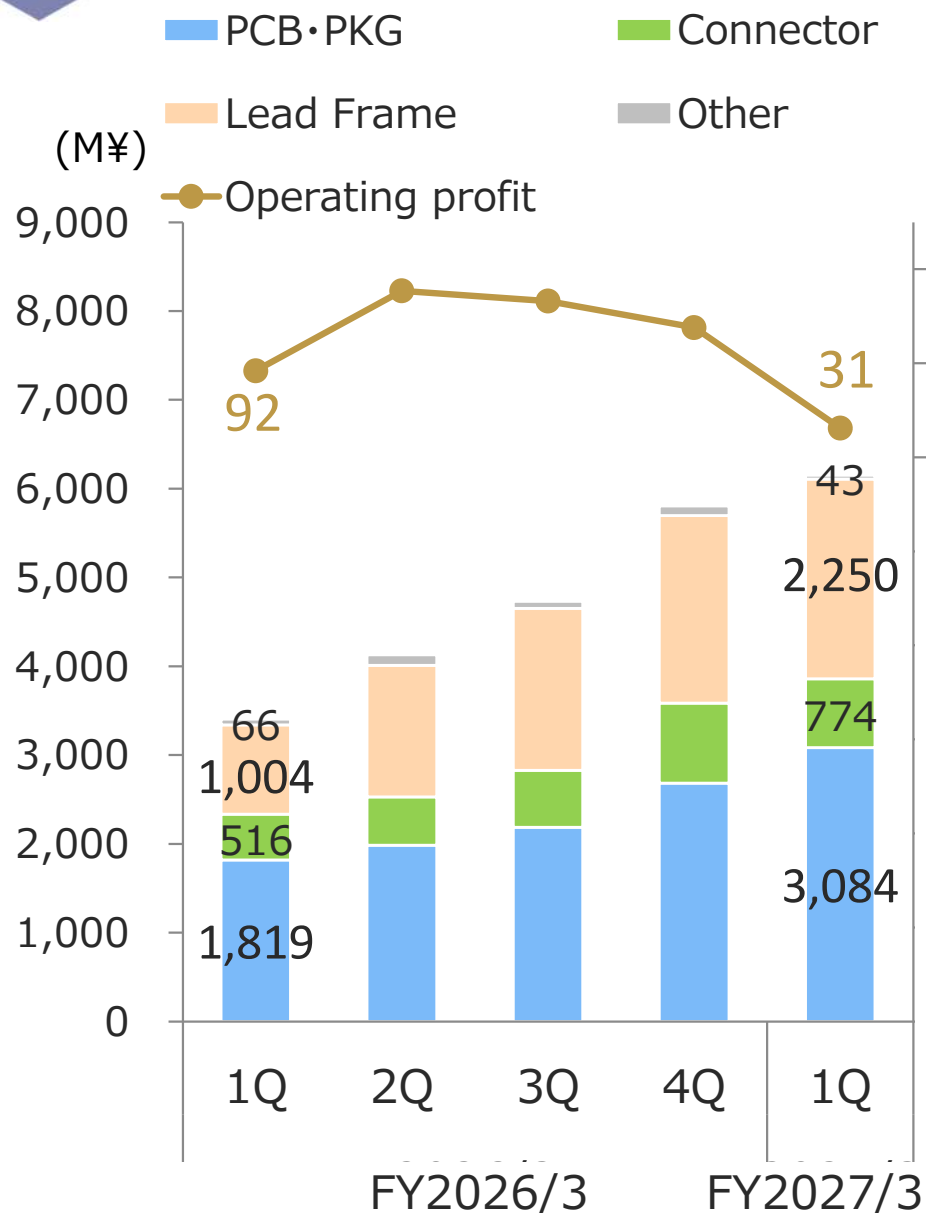
Noble Metal Prices (Monthly Average, per Gram)

※¹ : YoY (June 2025 → June 2026) Gold: ¥15,612 → ¥22,042 Palladium: ¥4,942 → ¥6,671

※² : QoQ (March 2026 → June 2026) Gold: ¥25,047 → ¥22,042 Palladium: ¥8,116 → ¥6,671

Net sales and operating profit (Quarterly basis)

Overview by Category



● Plating chemicals for printed circuit boards and semiconductor substrates

Strong demand for semiconductor package, module and memory applications driven by AI servers. High-end smartphone and PC demand remained solid, while higher noble metal prices supported revenue growth.

● Plating chemicals for connectors

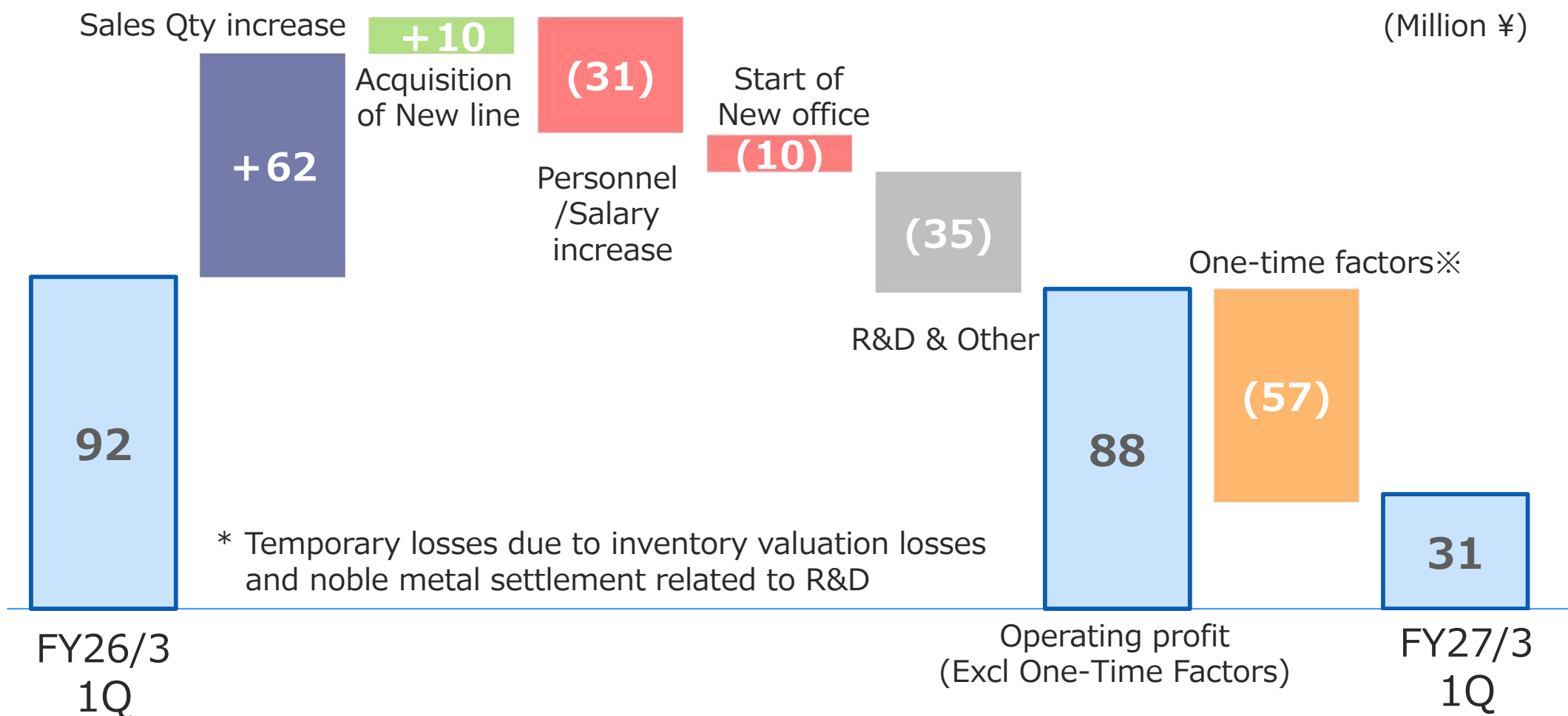
Revenue increased as higher demand for industrial equipment offset flat demand for smartphones and automotive applications.

● Plating chemicals for lead frame

Revenue increased as demand for consumer and automotive applications improved, data center demand grew significantly, and higher noble metal prices provided additional support.

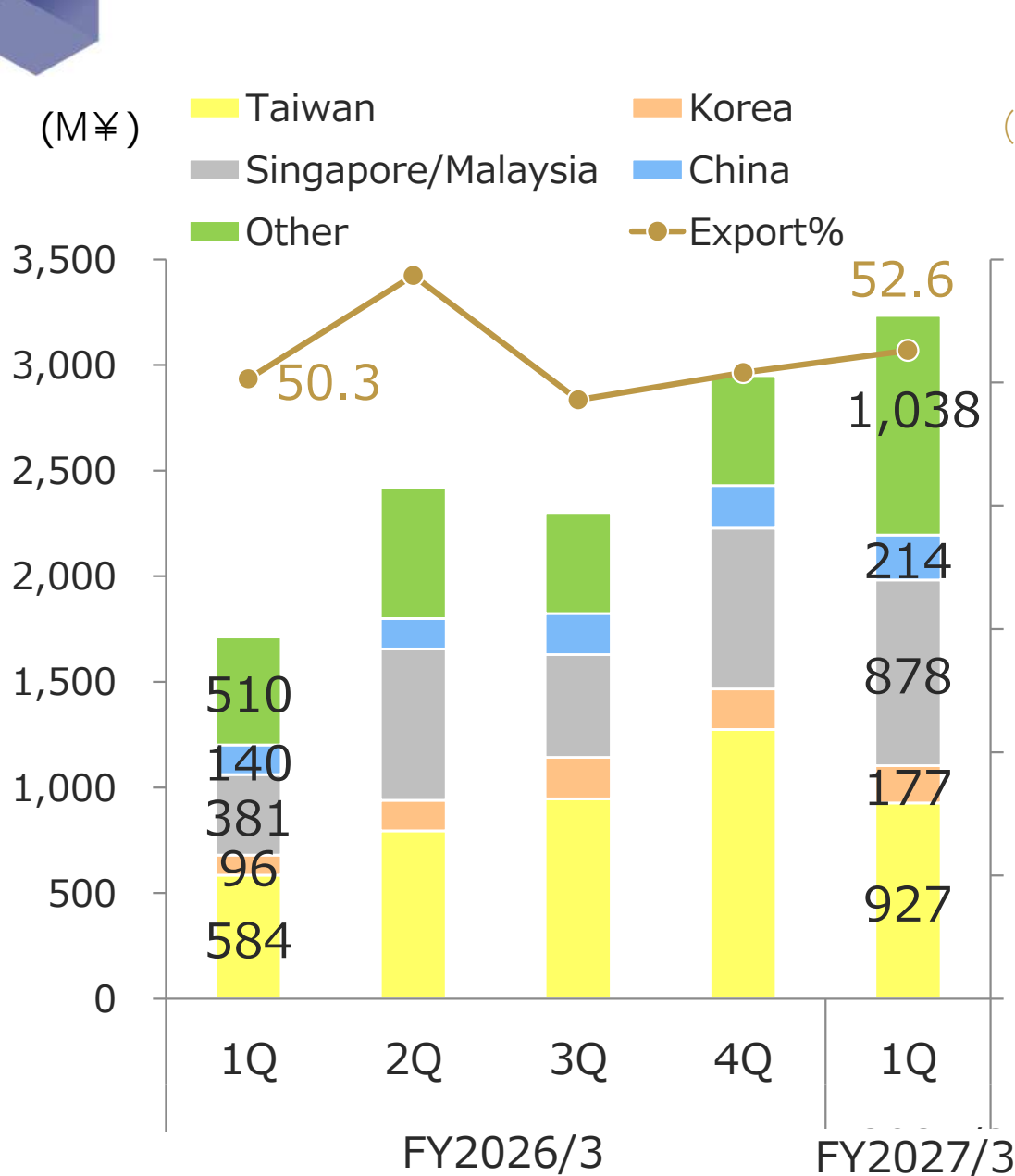
QoQ Operating profit breakdown

- Sales Volume: Strong memory demand driven by AI, with solid connector, PCB and lead frame demand. Volume increased.
- Operating Profit: Higher gross profit largely absorbed investments in human capital and R&D, but was offset by one-time factors from lower noble metal prices.



Note: The Company minimizes the impact of exchange rate fluctuations through forward exchange contracts.
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Net Sales by Export Regions (Quarterly basis)



Reason for Increase/Decrease

(%) ● Taiwan

Strong demand for AI server optical communication modules and consumer electronics lead frames, together with higher noble metal prices, drove revenue growth.

● Singapore/Malaysia

Recovering demand for lead frames in consumer and industrial equipment applications, solid package demand for PCs and servers, and higher noble metal prices drove revenue growth.

● Other

Revenue increased on stronger demand in the Philippines for package applications for PCs and servers.

Outlook for the Fiscal Year Ending March 2027

- Demand for AI servers and data centers is expected to remain strong, while industrial equipment demand continues to recover.
- AI-related demand is expected to remain robust, although recovery in some consumer applications may be moderated by memory supply constraints.
- Continue investing in human capital and R&D to strengthen the foundation for long-term growth.
- Full-year forecast unchanged, as the impact of Q1 noble metal price volatility is expected to be limited.

(M¥)	FY2026/3	FY2027/3	Y oY
Net sales	18,073	24,000	+32.8%
Operating profit	576	610	+5.8%
Ordinary profit	776	800	+3.1%
Gain on Specified investment shares	1,655	2,100	+26.8%
Net profit	1,803	2,170	+20.3%
Dividend (¥)	200	230	+ 30
ROE	11.5%	12.1%	—

Progress in sales of Specified Investment Shares

- The Company aims to reduce Specified Investment Shares to below 20% of net assets during the FY2026/3–FY2028/3 Medium-term Management Plan period.
- The market value of Specified Investment Shares increased from the previous fiscal year-end due to a significant rise in the share prices of certain holdings.
- There is no change to the planned disposal Specified Investment Shares for this fiscal year.

	2025 Jun	2025 Sep	2025 Dec	2026 Mar	2026 Jun
Amount sold ※ (M¥)	—	493	933	315	—
Market value of shares held (M¥)	6,740	8,416	9,308	10,743	17,956
Net assets (M¥)	13,891	15,566	16,659	18,064	22,315
Percentage of net assets (%)	48.5	54.1	55.9	59.5	80.5

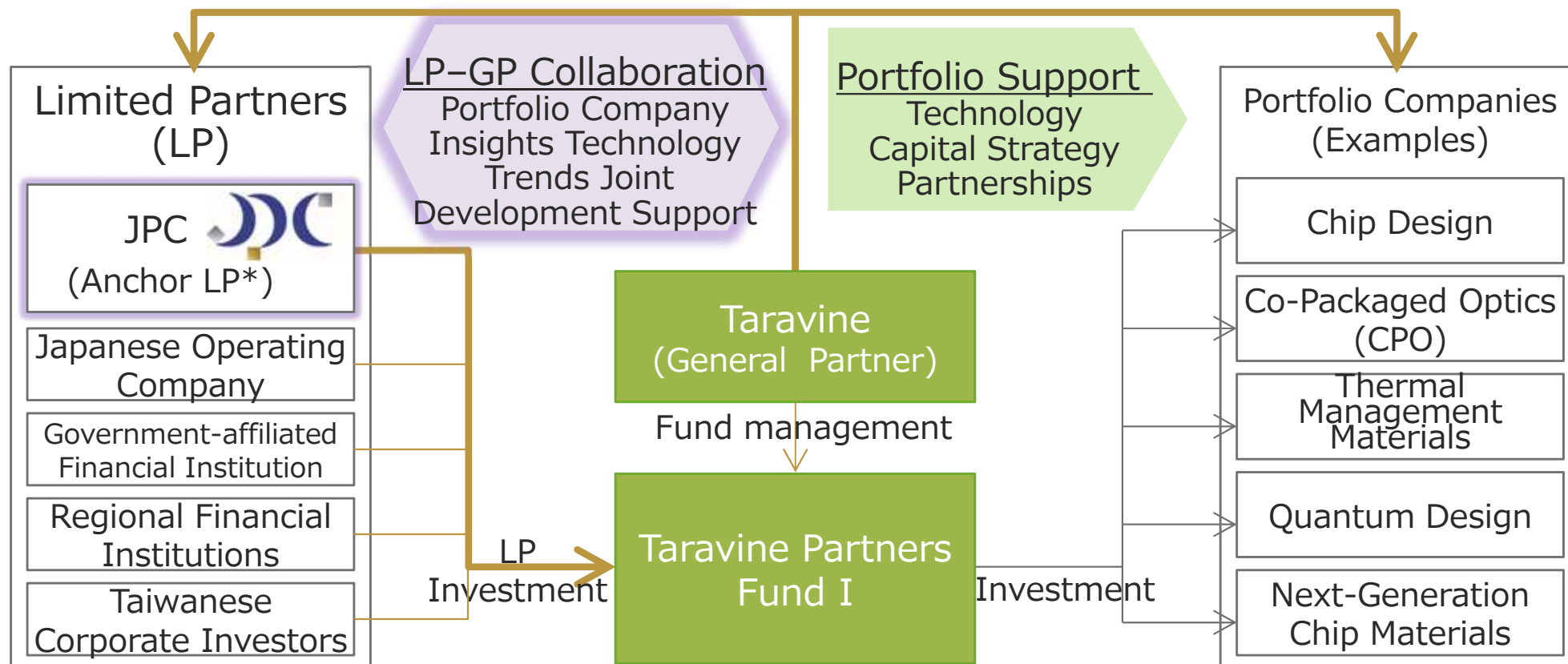
※ Amount sold during the relevant period

Topic: Investment in a Venture Capital Fund Focused on the Semiconductor Sector

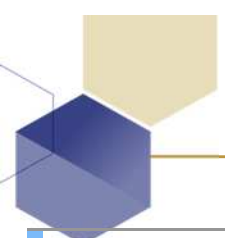
Background and Objectives

- Invest in early-stage companies in next-generation semiconductor materials and packaging.
- Support portfolio growth and build future partnerships.
- Leverage the fund manager's network and market intelligence.

Fund structure (Image)



* Anchor LP: A lead investor participating as a major limited partner from the fund's inception.



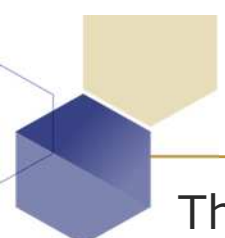
Appendix: Company Introduction

History

- July 1971 Establishment of JAPAN PURE CHEMICAL CO.,LTD.
- November 1999 Implementation of MBO
- December 2002 JASDAQ market listing
- March 2004 Listing on TSE Second Section
- March 2005 Listing on TSE First Section
- February 2019 Establishment of General incorporated foundation, JPC Scholarship Foundation
- April 2020 Certification as public interest incorporated foundation, JPC Scholarship Foundation
- April 2022 Moved to the Prime Market on TSE
- March 2026 Narimasu Office Established

Business Summary

- Fine chemical company supplying electronic materials which support development of the electronic components industry
- Top-class share in the worldwide market by narrowing the business targets to noble metal plating process
- Construct sales and technical support systems that can respond quickly to the rapidly changing industry
- Fab-light company that does not have large-scale manufacturing plants
- Provide technology to minimize the amount of noble metals used for connecting electronic components and contribute to effective use of mineral resources



Disclaimer

The materials used in the preparation of forecasts of results and predictions are based upon predicted trends in the industries related to the Company's operations. Accordingly, economic conditions both in Japan and overseas, fluctuations in exchange rates and other factors may influence forecasts of results. The predictions and forecasts made are based upon the information available as of June 30 2026.

There are a number of factors that cannot be predicted with certainty that may have an influence on these forecasts, including market conditions, competitors' actions, the performance of newly introduced products and services, and the global IT market and related markets. Accordingly, actual results may vary significantly from the forecasts presented in this document.

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